

STW65N65DM2AG

Automotive-grade N-channel 650 V, 0.042 Ω typ., 60 A Power MOSFET MDmesh[™] DM2 in a TO-247 package

Datasheet - production data

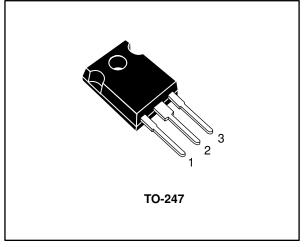
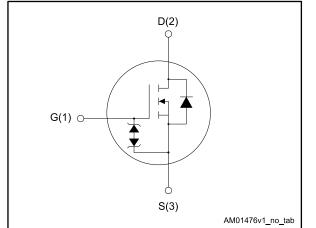


Figure 1: Internal schematic diagram



Features

Order code	Order code V _{DS}		ID	Ртот
STW65N65DM2AG	650 V	0.05 Ω	60 A	446 W

- Designed for automotive applications and AEC-Q101 qualified
- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Q_{rr}) and time (t_{rr}) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW65N65DM2AG	65N65DM2	TO-247	Tube

DocID028164 Rev 1

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	±25	V
	Drain current (continuous) at T _{case} = 25 °C	60	А
ID	Drain current (continuous) at T _{case} = 100 °C	38	A
I _{DM} ⁽¹⁾	Drain current (pulsed)	240	А
P _{TOT}	Total dissipation at $T_{case} = 25 \text{ °C}$	446	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
T _{stg}	Storage temperature	EE to 150	٦°
Tj	Operating junction temperature	-55 to 150	10

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} \leq 60 A, di/dt=800 A/µs; V_{DS} peak < V_(BR)DSS, V_{DD} = 80% V(BR)DSS.

⁽³⁾ $V_{DS} \le 520 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.28	°C M/
R _{thj-amb}	R _{thj-amb} Thermal resistance junction-ambient		°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive	8	А
E _{AS} ⁽¹⁾	Single pulse avalanche energy	1100	mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 **Electrical characteristics**

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	650			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 650 V$			10	
I _{DSS} Zero gate voltage de current		$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = 650 \ V, \\ T_{case} = 125 \ ^{\circ}C \end{array}$			100	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{D}} = 250 \ \mu\text{A}$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS}=10~V,~I_{D}=30~A$		0.042	0.05	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	5500	-	
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	210	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	3	-	p.
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 520 V, V_{GS} = 0 V	-	456	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	3.3	-	Ω
Qg	Total gate charge	V _{DD} = 520 V, I _D = 60 A,	-	120	-	
Q _{gs}	Gate-source charge	$V_{GS} = 10 V$ (see <i>Figure 15</i> :	-	27	-	nC
Q_gd	Gate-drain charge	"Gate charge test circuit")	-	58	-	

Table 6. Dynamic

Notes:

 $^{(1)}$ C_{oss \, eq.} is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 325 V, I_D = 30 A$	-	33	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Switching times test	-	13.5	-	
t _{d(off)}	Turn-off delay time	circuit for resistive load" and	-	114	-	ns
t _f	Fall time	Figure 19: "Switching time waveform")	-	11.5	-	



STW65N65DM2AG

Electrical characteristics

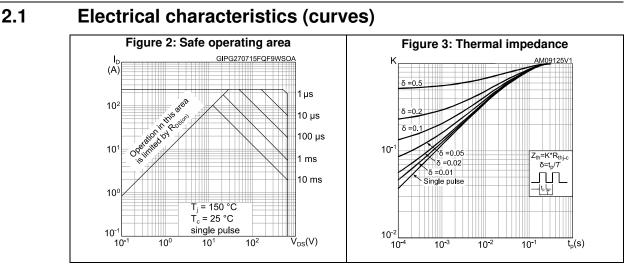
	l	able 8: Source-drain diode				,,
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		60	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		240	А
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS}=0~V,~I_{SD}=60~A$	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 60 A, di/dt = 100 A/μs,	-	154		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	0.94		μC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	12.2		А
t _{rr}	Reverse recovery time	I _{SD} = 60 A, di/dt = 100 A/μs,	-	288		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	3.65		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	25.4		А

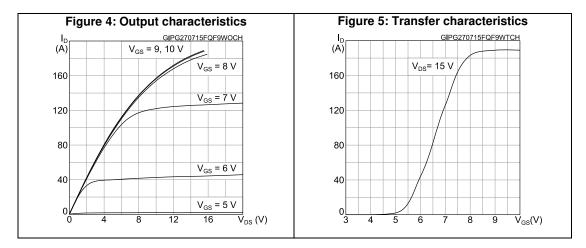
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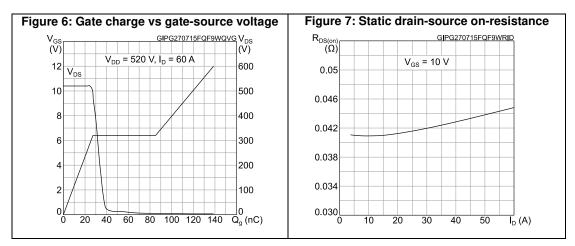
 $^{\left(1\right)}$ Pulse width is limited by safe operating area.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



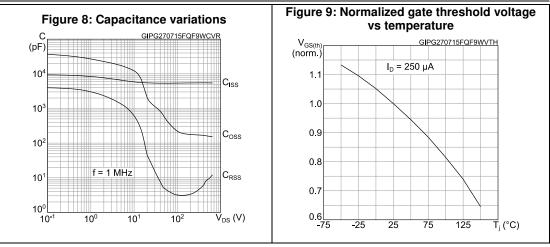


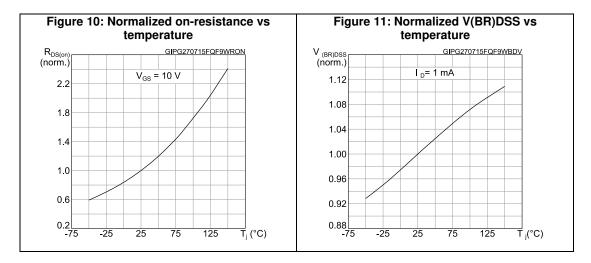


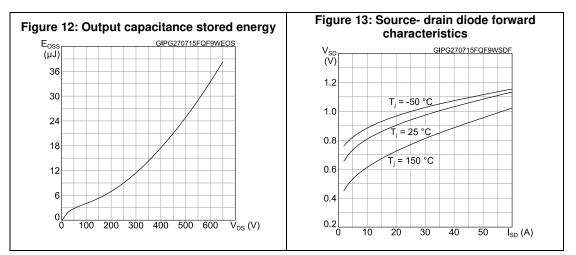




Electrical characteristics

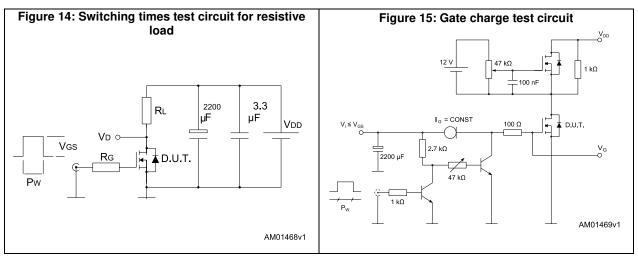


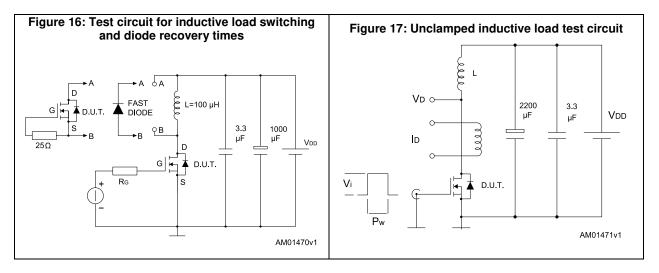


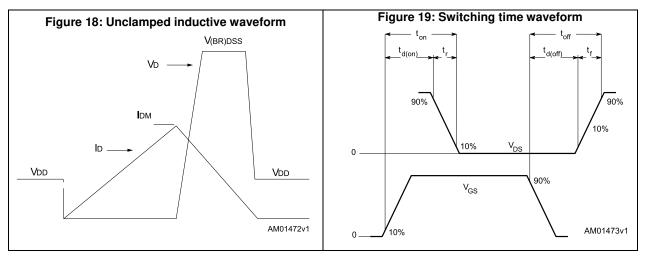


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3 Test circuits



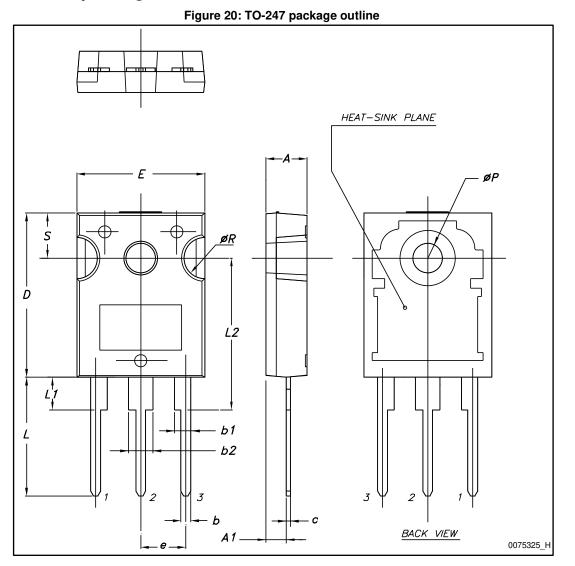




4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information





Package information

STW65N65DM2AG

normation			ST WOSINOSDINIZAG
	Table 9: TO-247 pacl	kage mechanical data	
Dim		mm.	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

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5 Revision history

Table 10: Document revision history

Date	Revision	Changes
04-Aug-2015	1	Initial release.



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